



Spark Plasma Sintering of Materials

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Message from the Guest Editor

Dear Colleagues,

Spark plasma sintering is attracting significant interests for the processing of difficult-to-sinter and advanced materials including bulk amorphous alloys, nanostructured and fine-grained materials, ultra high temperature ceramics, nanocomposites, and coatings. This Special Issue aims to highlight the recent developments related to processing/synthesis, process modelling, microstructure/properties characterization, and scalability for spark plasma sintering of materials.

Dr. Sandip P. Harimkar
Guest Editor





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Message from the Editor-in-Chief

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